HC1

High current inductor





Product description

- Designed for high current, low voltage applications
- · Low DCR, high efficiency
- Foil construction for higher frequency circuit designs
- Frequency range 1kHz to 1MHz
- · Ferrite core material

Applications

- Distributed power systems DC-DC converters
- General-purpose low voltage supplies
- · Computer systems
- Servers
- Industrial Equipment
- · Data networking and storage systems

Environmental data

- Storage temperature range (component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise).
- Solder reflow temperature: J-STD-020D







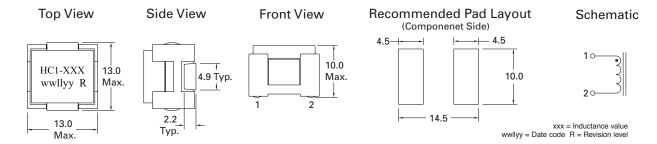
Product specifications

Part number	OCL1 (µH) ±15%	I _{rms} ² amps (approx.)	I _{sat} ³ amps (approx.)	DCR (Ω) maximum @ 20°C	Volt-μsec⁴ (V μs) ref.
HC1-R22-R	0.218	51.42	40.5	0.00036	1.83
HC1-R30-R	0.291	51.42	31.8	0.00036	1.83
HC1-R57-R	0.572	37.83	33.4	0.00068	3.66
HC1-R87-R	0.866	28.01	31.0	0.00123	5.49
HC1-1R0-R	1.12	28.01	25.4	0.00123	5.49
HC1-1R7-R	1.66	22.30	22.2	0.0020	7.33
HC1-2R3-R	2.29	22.30	16.7	0.0020	7.33
HC1-3R6-R	3.59	16.76	13.4	0.0035	9.16
HC1-5R1-R	5.15	12.79	11.2	0.0057	10.99
HC1-7R8-R	7.85	12.79	6.7	0.0057	10.99
HC1-100-R	10.5	12.79	5.3	0.0057	10.99

- 1. OCL (Open Circuit Inductance) Test parameters: 300kHz, .25V $_{ms}$, 0.0Adc & I $_{sat}$, 2. I $_{ms}$ Amps for approximately Δ T of 40°C. DC current for an approximate Δ T of 40°C without core loss. Derating is necessary for AC currents. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 3. I Amps Peak for approximately 30% rolloff @ 20°C.

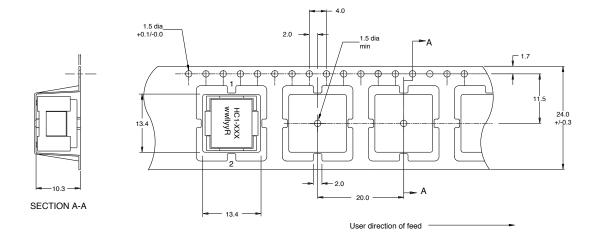
- 4. Applied Volt-Time product (V-µs) across the inductor. This value represents the applied V-µs at 200kHz necessary to generate a core loss equal to 10% of the total losses for 40°C temperature rise. See Core Loss Graph.
- 5. Part number definition HC1-xxx-R:
 - HC1 = Product code and size
 - -xxx = Inductance value
 - $R = \mbox{Decimal point}$ (if no "R" is present, last character equals number of zeros)
 - -R Suffix = RoHS compliant

Dimensions-mm



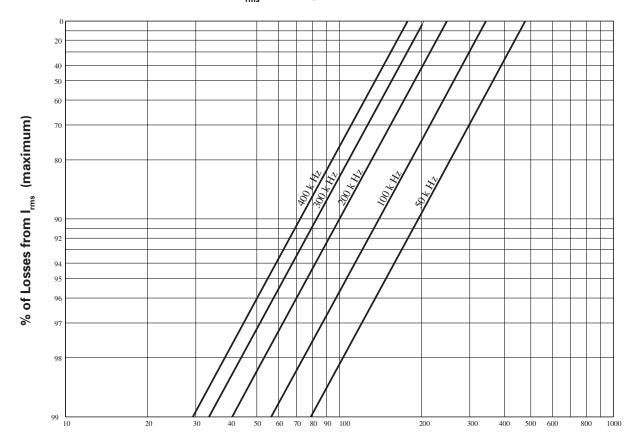
Packaging information (mm)

Supplied in tape and reel packaging, 250 parts per reel, 13" diameter reel.



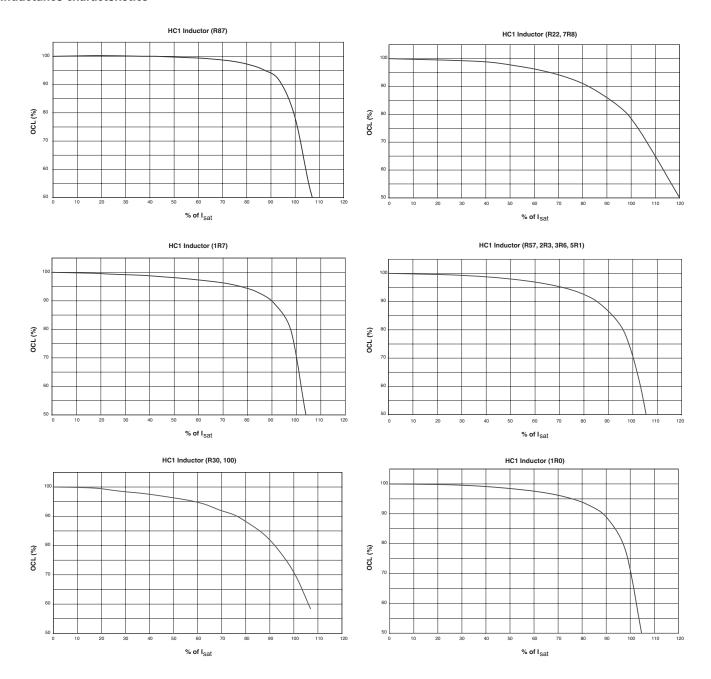
Core loss

$\mathbf{I}_{\mathrm{rms}}$ Derating With Core Loss



% of Applied Volt- μ -Seconds

Inductance characteristics



Solder reflow profile

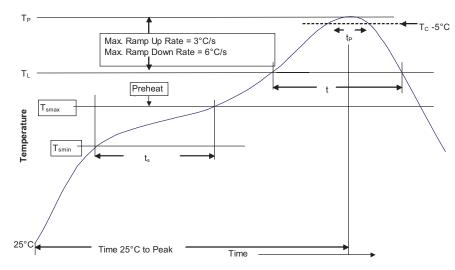


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T _{smin})	100°C		
• Temperature max. (T _{smax})	150°C	200°C	
• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T_{smax} to T_{p}	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)	20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{Smax})	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

 $^{^{*}}$ Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.